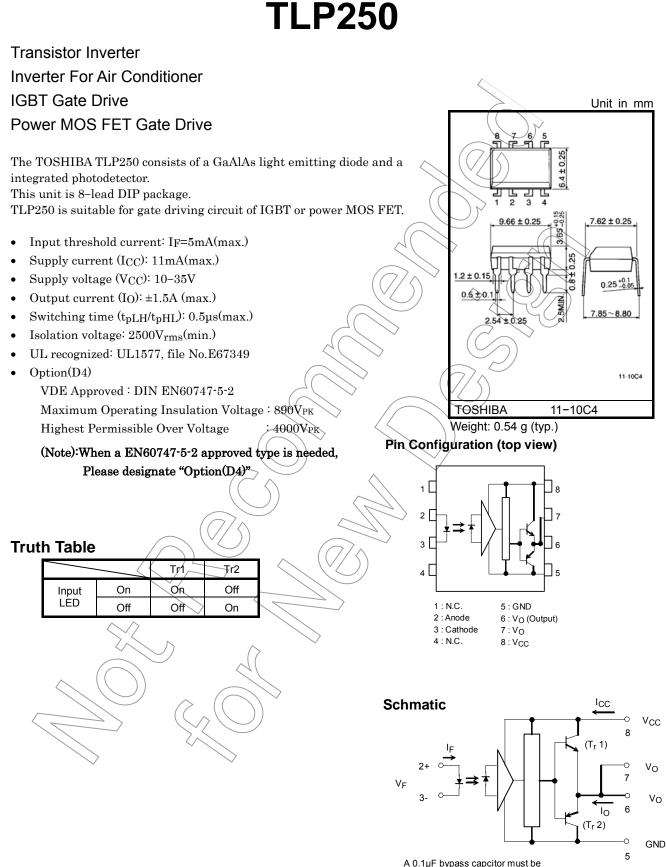
TOSHIBA Photocoupler GaAłAs Ired & Photo-IC



connected between pin 8 and 5 (See Note 5).

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current	١ <sub>F</sub>	20	mA	
LED	Forward current derating (Ta ≥ 70°C)	ΔΙ <sub>F</sub> / ΔΤα	-0.36	mA / °C	
	Peak transient forward curent	I <sub>FPT</sub>	1	А	
	Reverse voltage	V <sub>R</sub>	5	V	
	Junction temperature	Tj	125	°C	
	"H"peak output current (P <sub>W</sub> ≤ 2.5µs,f ≤ 15kHz)	(Note 2)	I <sub>OPH</sub>	(-1.5)	✓ A
	"L"peak output current ( $P_W \le 2.5 \mu s, f \le 15 kHz$ )	(Note 2)	I <sub>OPL</sub>	+1.5	A
	Output voltage	(Ta ≤ 70°C)	Vo	35	V
đ	Output voltage	(Ta = 85°C)	VO	24	v
Detector	Supply voltage	(Ta ≤ 70°C)	Vac	35	V
ă		(Ta = 85°C)	VOL	24	v
	Output voltage derating (Ta ≥ 70°C)	ΔνολΔτα	-0.73	O°YV	
	Supply voltage derating (Ta $\geq$ 70°C)	$\Delta V_{CC} / \Delta Ta$	-0.73	V/°C	
	Junction temperature	G	Ti A	125	, C
Oper	ating frequency	(Note 3)	/ )) f	⊘ 25()	)
Oper	ating temperature range			-20~85	₁ //°C
Stora	ge temperature range		> T <sub>stg</sub>	=55~125	°c
Lead	soldering temperature (10 s)	T <sub>sol</sub>	260	°C	
Isolat	ion voltage (AC, 1 min., R.H.≤ 60%)	(Note 4)	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Pulse width  $P_W \le 1\mu s$ , 300pps
- Note 2: Exporenential waveform
- Note 3: Exporemential waveform,  $I_{OPH} \leq -1.0A(\leq 2.5\mu s)$ ,  $I_{OPL} \leq +1.0A(\leq 2.5\mu s)$
- Note 4: Device considerd a two terminal device: Pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.
- Note 5: A ceramic capacitor(0.1µF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching proparty. The total lead length between capacitor and coupler should not exceed 1cm.

### **Recommended Operating Conditions**

Characteristic		Symbol	Min	Min Typ. Max		ах	Unit	
Input current, on	(Note6)	(IF(ON)	7	8	10		mA	
Input voltage, off	$\sim$	VF(OFF)	0	_	0.8		V	
Supply voltage	$\sim$	Vcc	15		30	20	V	
Peak output current		IOPH/IOPL	-		±0.5		А	
Operating temperature		T <sub>opr</sub>	-20	25	70	85	°C	

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note 6: Input signal rise time(fall time)<0.5µs.

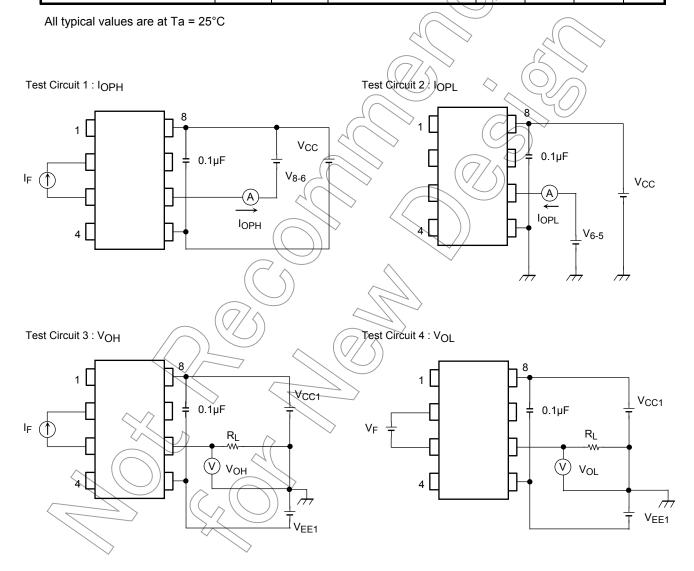
## Electrical Characteristics (Ta = $-20 \sim 70^{\circ}$ C, unless otherwise specified)

Characteristic		Symbol	Test Cir– cuit	Test Condition	Min	Тур.*	Max	Unit	
Input forward voltage		VF	_	I <sub>F</sub> = 10 mA , Ta <b>=</b> 25°C		1.6	1.8	V	
Temperature coefficient of forward voltage		ΔV <sub>F</sub> / ΔTa	_	I <sub>F</sub> = 10 mA	ĸ	-2.0	_	mV / °C	
Input reverse current		I <sub>R</sub>	_	V <sub>R</sub> = 5V, Ta = 25°C	$\rightarrow$		10	μA	
Input capacitance		CT	_	V = 0 , f = 1MHz , Ta = 25°C	-((	45	250	pF	
Output current	"H" level	IOPH	1	$V_{CC} = 30V$ $I_F = 10 \text{ mA}$ $V_{8-6} = 4V$	-0.5	-1.5		А	
Output current	"L" level	I <sub>OPL</sub>	2	(*1) $I_F = 0$ $V_{6-5} = 2.5V$	0.5	2	_	A	
Output voltage	"H" level	V <sub>OH</sub>	3	$V_{CC1} = +15V, V_{EE1} = -15V$ $R_L = 200\Omega, I_F = 5mA$	)/11	12.8		V	
Oulput voltage	"L" level	V <sub>OL</sub>	4	$V_{CC1} = +15V, V_{EE1} = -15V$ $R_L = 200\Omega, V_F = 0.8V$	_	-14.2	-12.5	v	
	"H" level	Іссн	_	$V_{CC} = 30V, I_F = 10mA$ Ta = 25°C	<u> </u>	$\bigcirc$	$\rightarrow$ –		
Supply current				$V_{CC} = 30V, I_F = 10mA$	$-\langle$	LĘ(	/ 11	mA	
	"L" level	ICCL	_	V <sub>CC</sub> = 30V, I <sub>F</sub> = 0mA Ta = 25℃	Œ	7.5	_		
				V <sub>CC</sub> = 30V, I <sub>F</sub> = 0mA		/ _	11		
Threshold input current	"Output L→H"	I <sub>FLH</sub>		V <sub>CC1</sub> = +15V, V <sub>EE1</sub> = -15V R <sub>L</sub> = 200Ω, V <sub>O</sub> > 0V	$\supset$	1.2	5	mA	
Threshold input voltage	"Output H→L"	V <sub>FHL</sub>		V <sub>CC1</sub> = +15V, V <sub>EE1</sub> = -15V R <sub>L</sub> = 200Ω, V <sub>Q</sub> < 0V	0.8	_	_	V	
Supply voltage		V <sub>CC</sub> (	(-)		10	_	35	V	
Capacitance (input-output)		CS .		V <sub>S</sub> = 0 , f = 1MHz Ta = 25℃	_	1.0	2.0	pF	
Resistance(input-ou	Rs	V_	V <sub>S</sub> = 500V , Ta = 25°C R.H.≤ 60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω		

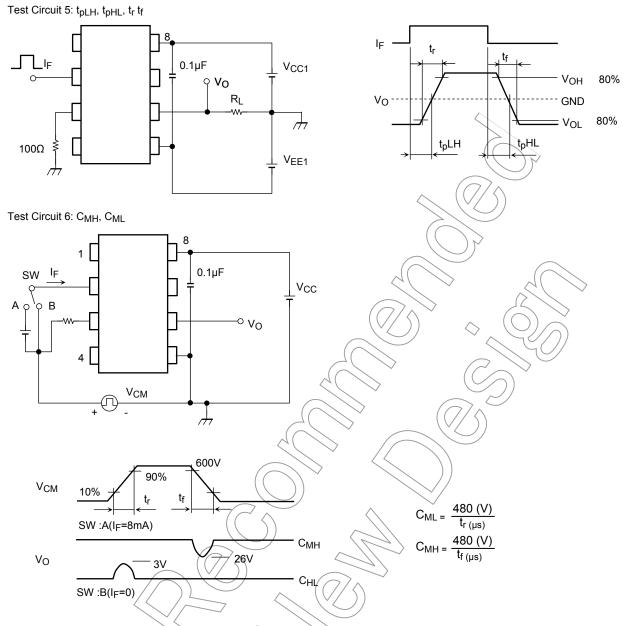
\* All typical values are at  $Ta = 25^{\circ}C$  (\*1): Duration of 10 time  $\leq 50 \mu s$ 

### Switching Characteristics (Ta = $-20 \sim 70^{\circ}$ C, unless otherwise specified)

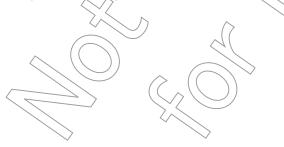
Characteristic		Symbol	Test Cir– cuit	Test Condition	Min	Тур.*	Max	Unit
Propagation	L→H	t <sub>pLH</sub>	- 5	I <sub>F</sub> = 8mA V <sub>CC1</sub> = +15V, V <sub>EE1</sub> = −15V	—	0.15	0.5	μs
delay time	H→L	t <sub>pHL</sub>			_	0.15	0.5	
Output rise time		tr		$R_L = 200\Omega$	$\langle \rangle$	-	—	μο
Output fall time		t <sub>f</sub>			-((	$\overline{\langle}$	—	
Common mode transient immunity at high level output Common mode transient immunity at low level output		C <sub>MH</sub>	- 6	V <sub>CM</sub> = 600V, I <sub>F</sub> = 8mA V <sub>CC</sub> = 30V, Ta = 25°C	-5000	$\underline{\mathcal{O}}$	_	V / µs
		C <sub>ML</sub>		V <sub>CM</sub> = 600V, I <sub>F</sub> = 0mA V <sub>CC</sub> = 30V, Ta = 25°C	5000	_	_	V / µs



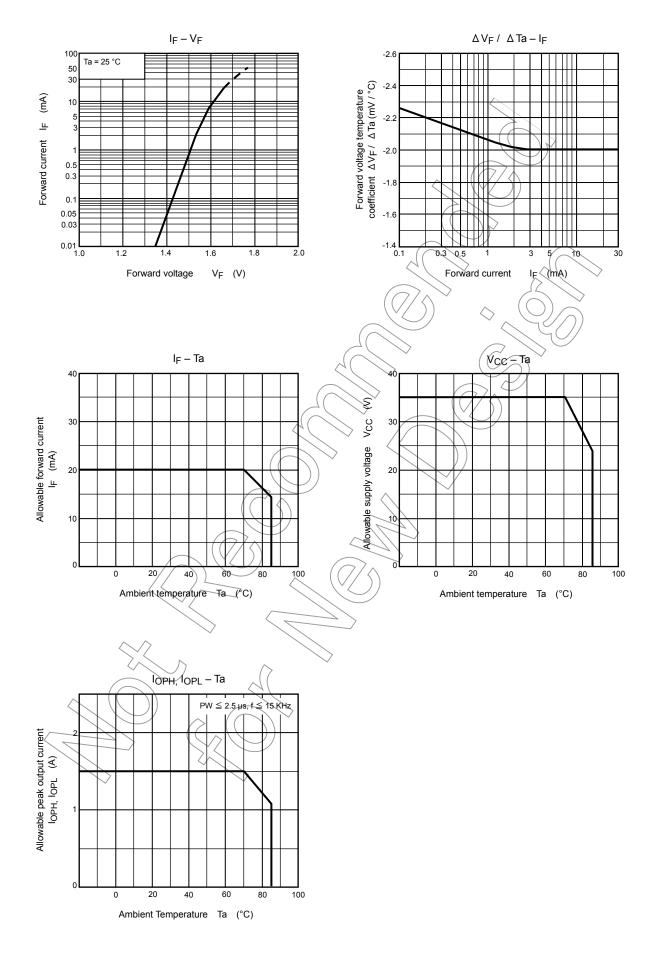




 $C_{ML}(C_{MH})$  is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.



# TOSHIBA



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